Disclaimer: This presentation is for informational purposes. The development, release, and timing of any features or functionality described in this document remains at the sole discretion of Oracle.

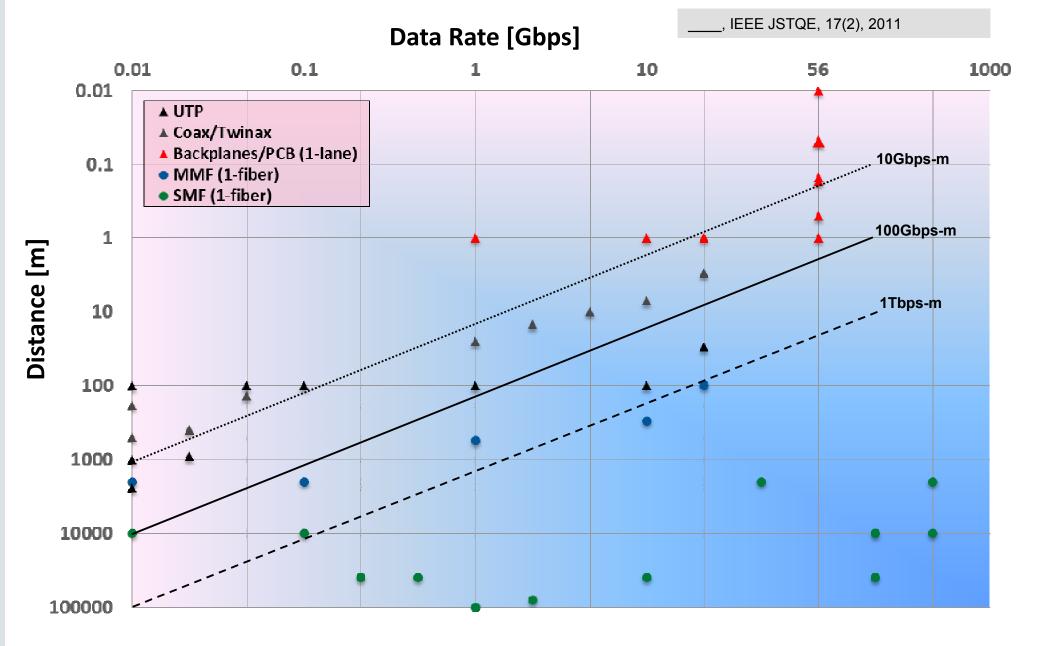


http://www.oracle.com/us/products/networking/overview/index.html

Optical Interconnect Packaging for the Cloud IEEE ECTC 2016

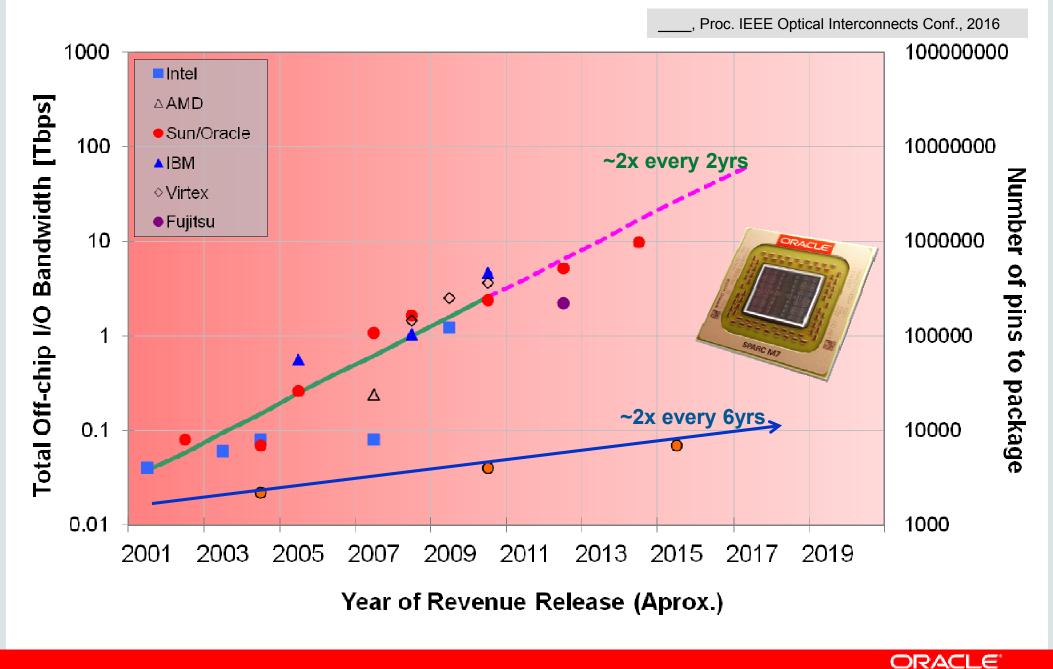
A. V. Krishnamoorthy Architect and Chief Technologist, Photonics Oracle Networking

Optical Link Technology Penetration



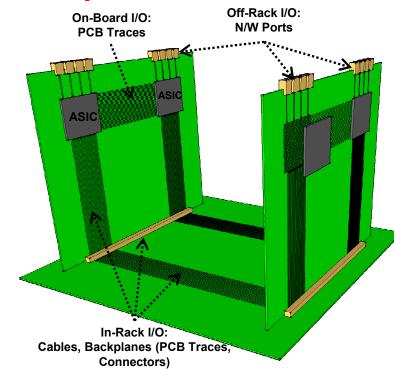
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Processor IO Requirements

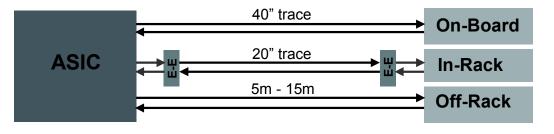


System Interconnect Evolution --- The Past

Mostly Electrical



- 2.5Gbps-15Gbps/Lane
- LR SerDes
 - Re-timers required at every hop
- BW*Density Limited
 - Both ASIC and front panel
- BW*Distance Limited

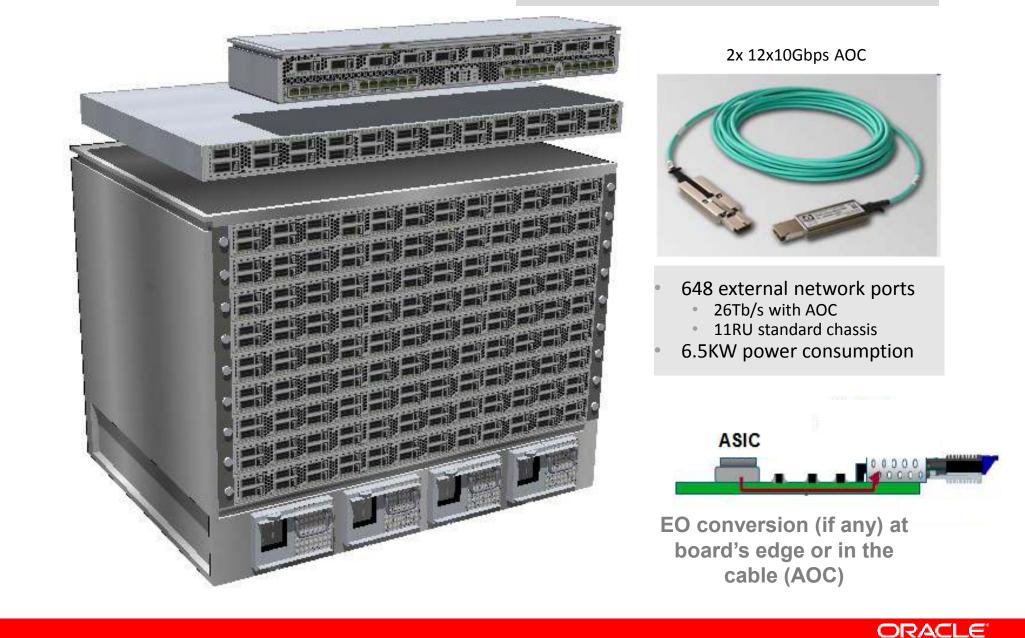




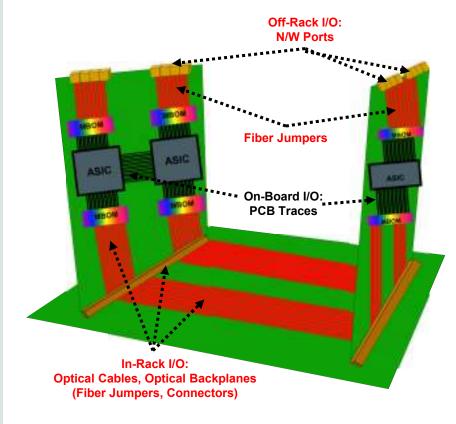


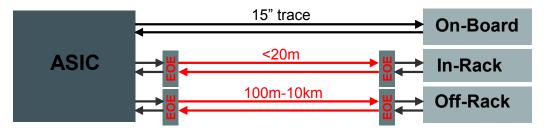
Network System Realization --- Magnum M9

O. Torudbakken & A. Krishnamoorthy, OFC OTu3H.1, 2013



System Interconnect Evolution --- The Present Mostly Optical





- 25+Gbps/Lane
- SR SerDes
- Re-timers optional
- Optics replace the lossiest Cu interconnects
- Eliminates front panel bandwidth-density limit
 - At least 8x improvement
- ASIC still bandwidth-density limited
- Improved signaling across entire system





Network System Realization --- The Present Nano-Magnum, 2016

, Proc. IEEE Optical Interconnects Conf., 2016



Leaf: >4Tb/s; <0.3KW



Spine: >24Tb/s; <3KW



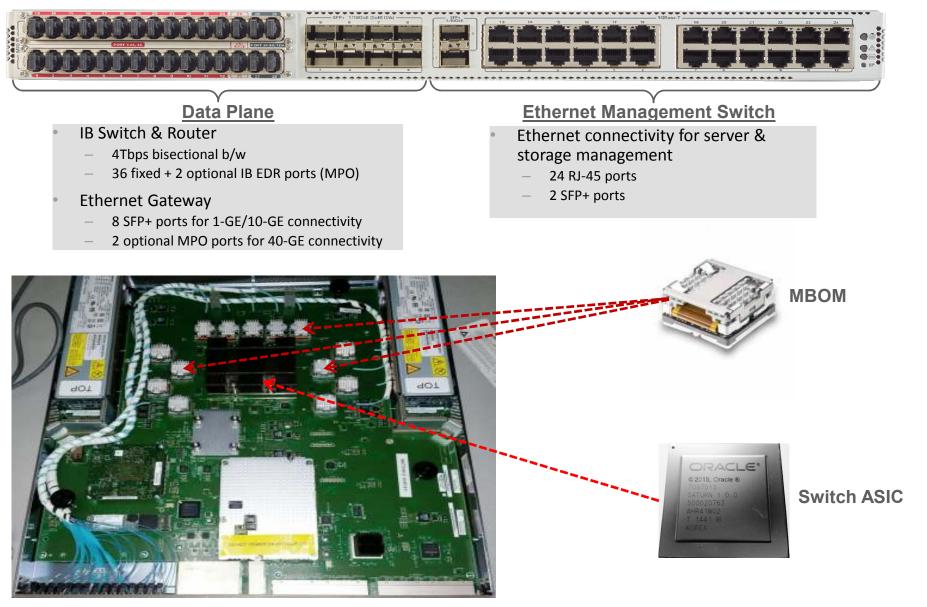
Virtualized I/O & SDN



Oracle InfiniBand Switch IS2-46

Leaf Switch

, Proc. IEEE Optical Interconnects Conf., 2016





Oracle InfiniBand Switch IS2-254

Spine Switch

Proc. IEEE Optical Interconnects Conf., 2016

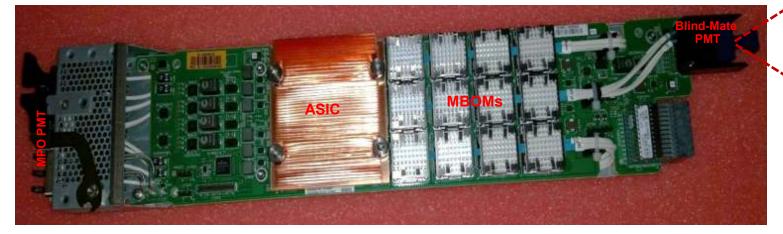


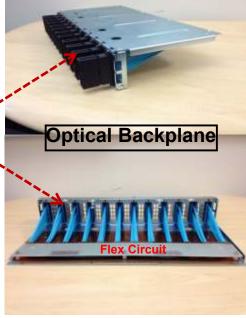
System Interfaces

- IB Switch & Router Uplinks
 - 12 EDR ports (4 x 12x)
- Ethernet Gateways
- 2 MPO ports for 40-GE connectivity
- Ethernet Management
 - 4 RJ45 ports for 1-GE connectivity

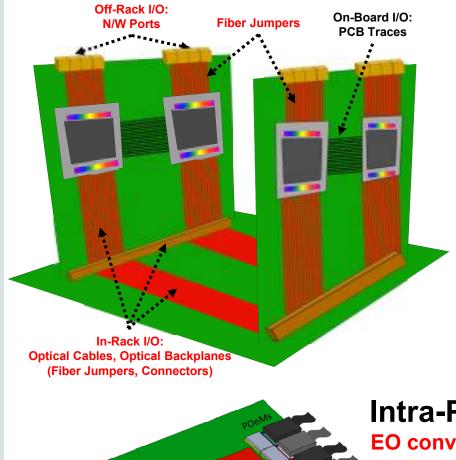
Module Slots

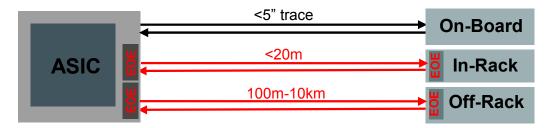
- Switch Modules
- Line and Fabric; 24Tbps switching capacity;
- I/O Modules
 - 4x10GBase-T, 4x40-GE, 16x10-GE
 - 2x16G FC; 4xIB-EDR Extended Reach (40km)
- Network Services Modules





System Interconnect Evolution --- The Future The Last 100mm





- 50+Gbps/Lane
- Integration of the high-speed interfaces at the package substrate (MCM)
 - Package Opto-Electronic Module (POEM)
- Lightweight (XSR/USR) SerDes
 - Optimal energy efficiency
 - No Re-timers
- Addresses bw*density limitations at the ASIC

Intra-Package Optics

EO conversion next to ASIC die

Power Reduction Potential: Another 3.5x? R&D prototype 16 port switch, 20Gbps/port, GbE signaling: <20pJ/switched bit with VCSELS and CMOS switch flip-chip co-packaged _____, IEEE JSTQE, 17(2), 2011

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Take-aways

- Bandwidth-Distance ("Scale-out") and Bandwidth-Density ("Scale-up") requirements are driving adoption of optical technologies
- For scale-out, growth in bandwidth-distance products continue to drive optics adoption
 - 100Gbps-m for multi-mode; 1Tbps-m (or 1Gbps-km) for single-mode
- For scale-up, compute trends continue to drive single-lane data rates
 Doubles every 3-4 years to balance bandwidth requirements to pin limitations
- The electrical channel continues to be a major contributor to silicon complexity and to the overall system power consumption
 - Bringing the optics closer to the silicon enables performance scale-up and efficiency in next generation systems
- Oracle has announced a family of performance-leading all-opticallyinterconnected switching platforms

- 49.1Tbps bandwidth, 450ns latency, 2U chassis, 16X improvement in Size*Power